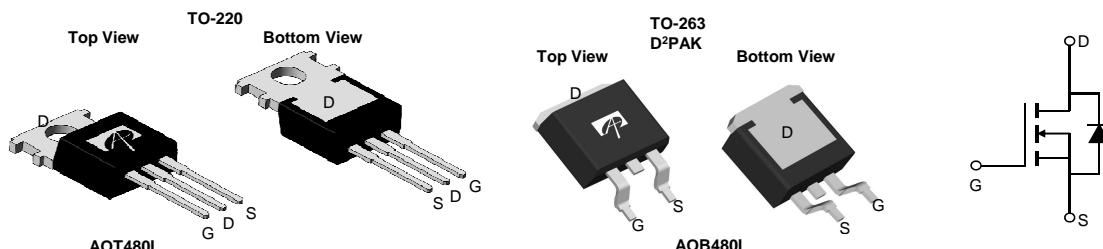


General Description

The AOT480L & AOB480L is fabricated with SDMOS™ trench technology that combines excellent $R_{DS(ON)}$ with low gate charge & low Q_{rr} . The result is outstanding efficiency with controlled switching behavior. This universal technology is well suited for PWM, load switching and general purpose applications.

Product Summary

V_{DS}	80V
I_D (at $V_{GS}=10V$)	180A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 4.5mΩ (< 4.2mΩ*)
$R_{DS(ON)}$ (at $V_{GS} = 7V$)	< 5.5mΩ (< 5.2mΩ*)

 100% UIS Tested
 100% R_g Tested


Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT480L	TO-220	Tube	1000
AOB480L	TO-263	Tape & Reel	800

Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	80	V
Gate-Source Voltage	V_{GS}	± 25	V
Continuous Drain Current ^G	I_D	180	A
$T_C=100^\circ C$		134	
Pulsed Drain Current ^C	I_{DM}	500	
Continuous Drain Current	I_{DSM}	15	A
$T_A=70^\circ C$		12	
Avalanche Current ^C	I_{AS}, I_{AR}	90	A
Avalanche energy $L=0.1mH$ ^C	E_{AS}, E_{AR}	405	mJ
V_{GS} Spike	20ms	V_{SPIKE}	V
Power Dissipation ^B	P_D	333	W
$T_C=100^\circ C$		167	
Power Dissipation ^A	P_{DSM}	1.9	W
$T_A=70^\circ C$		1.2	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A $t \leq 10s$	$R_{\theta JA}$	12	15	°C/W
Maximum Junction-to-Ambient ^{A,D} Steady-State		54	65	°C/W
Maximum Junction-to-Case Steady-State	$R_{\theta JC}$	0.35	0.45	°C/W

* Surface mount package TO263

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	80			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=80\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			10 50	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm25\text{V}$			±100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=5\text{V}, I_D=250\mu\text{A}$	2	2.8	4	V
$I_{\text{D(ON)}}$	On state drain current	$V_{GS}=10\text{V}, V_{DS}=5\text{V}$	500			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$ TO220 $T_J=125^\circ\text{C}$		3.7	4.5	$\text{m}\Omega$
		$V_{GS}=7\text{V}, I_D=20\text{A}$ TO220		6.1	7.3	
		$V_{GS}=10\text{V}, I_D=20\text{A}$ TO263		4.2	5.5	$\text{m}\Omega$
		$V_{GS}=7\text{V}, I_D=20\text{A}$ TO263		3.4	4.2	$\text{m}\Omega$
				3.9	5.2	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=20\text{A}$		60		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.6	1	V
I_S	Maximum Body-Diode Continuous Current				180	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=40\text{V}, f=1\text{MHz}$	5200	6520	7820	pF
C_{oss}	Output Capacitance		570	810	1060	pF
C_{rss}	Reverse Transfer Capacitance		185	310	430	pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	0.3	0.64	1	Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=40\text{V}, I_D=20\text{A}$	92	116	140	nC
Q_{gs}	Gate Source Charge		24	30	36	nC
Q_{gd}	Gate Drain Charge		23	38	53	nC
$t_{\text{D(on)}}$	Turn-On DelayTime	$V_{GS}=10\text{V}, V_{DS}=40\text{V}, R_L=2\Omega, R_{\text{GEN}}=3\Omega$		31.5		ns
t_r	Turn-On Rise Time			33		ns
$t_{\text{D(off)}}$	Turn-Off DelayTime			46		ns
t_f	Turn-Off Fall Time			17.5		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$	20	28	36	ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$	90	132	170	nC

A. The value of R_{fJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The Power dissipation P_{DSM} is based on R_{fJA} and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design, and the maximum temperature of 175°C may be used if the PCB allows it.

B. The power dissipation P_D is based on $T_{J(\text{MAX})}=175^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=175^\circ\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.

D. The R_{fJA} is the sum of the thermal impedance from junction to case R_{fJC} and case to ambient.

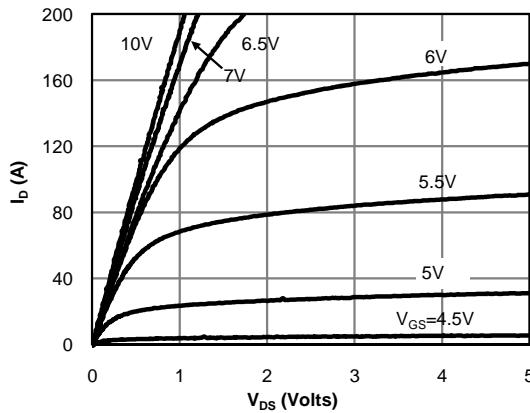
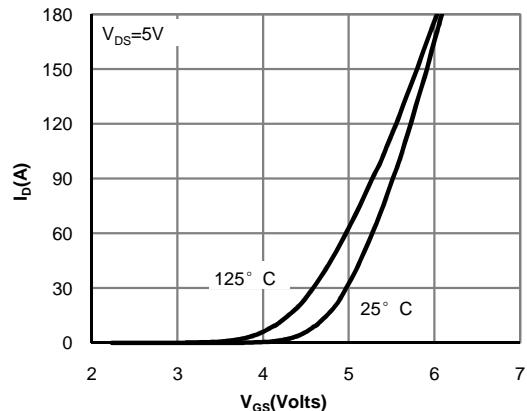
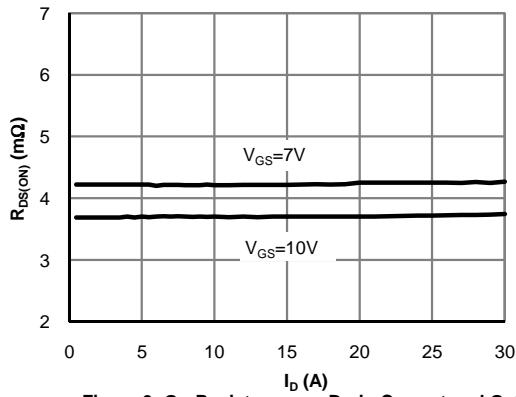
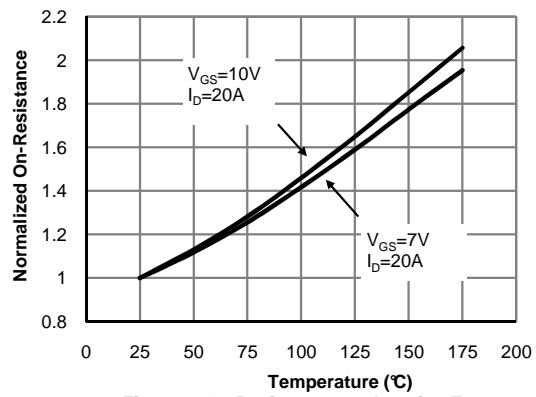
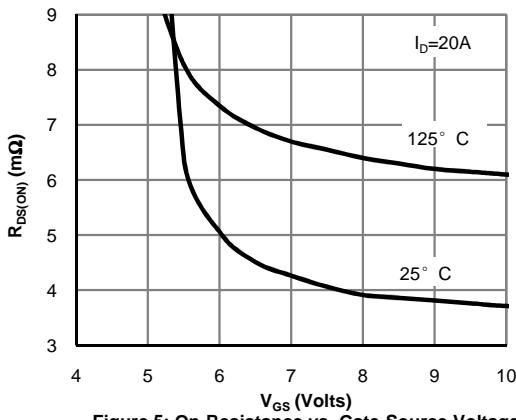
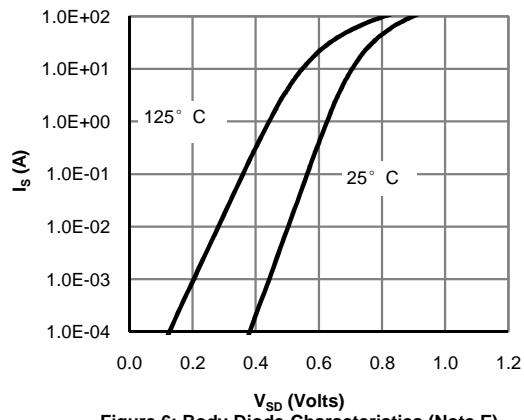
E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

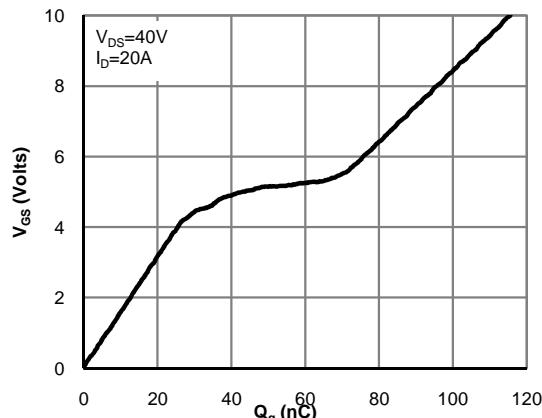
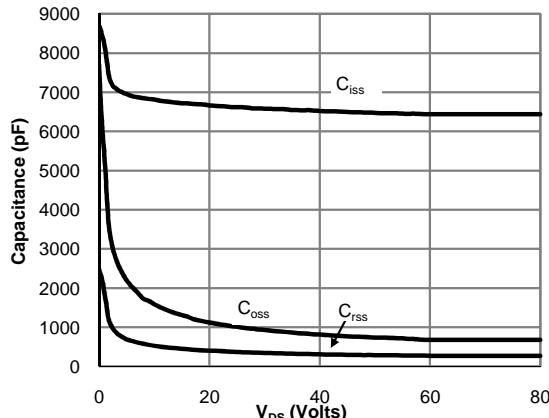
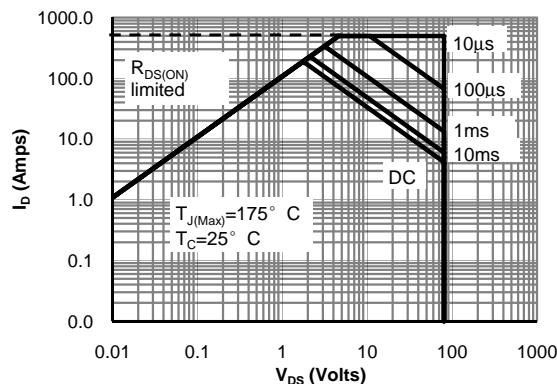
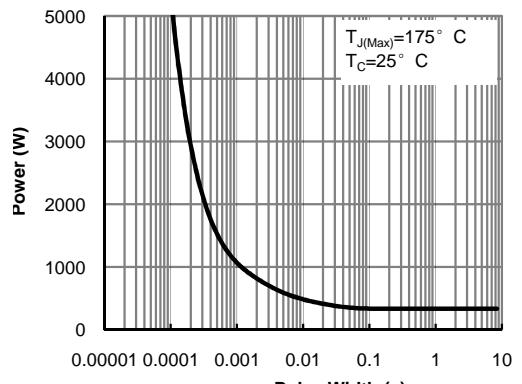
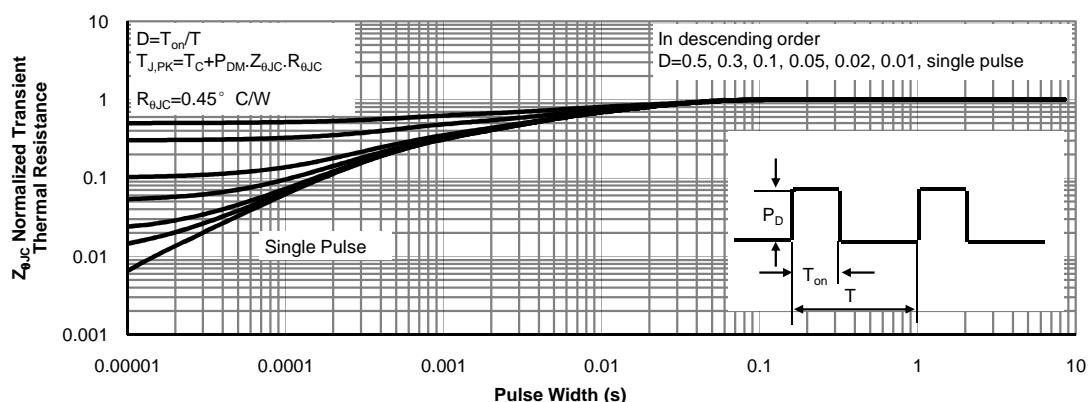
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(\text{MAX})}=175^\circ\text{C}$. The SOA curve provides a single pulse rating.

G. The maximum current limited by package.

H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: On-Region Characteristics (Note E)

Figure 2: Transfer Characteristics (Note E)

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

Figure 4: On-Resistance vs. Junction Temperature (Note E)

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

Figure 10: Single Pulse Power Rating Junction-to-Case (Note F)

Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

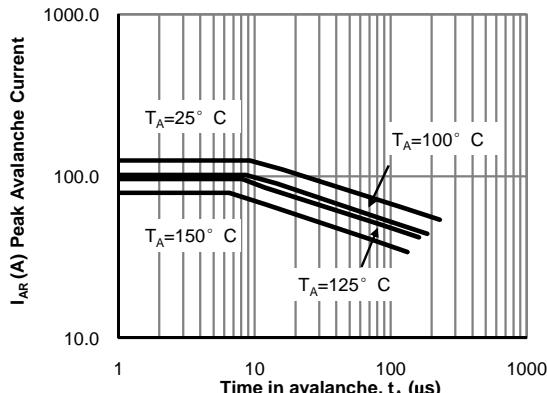
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 12: Single Pulse Avalanche capability (Note C)

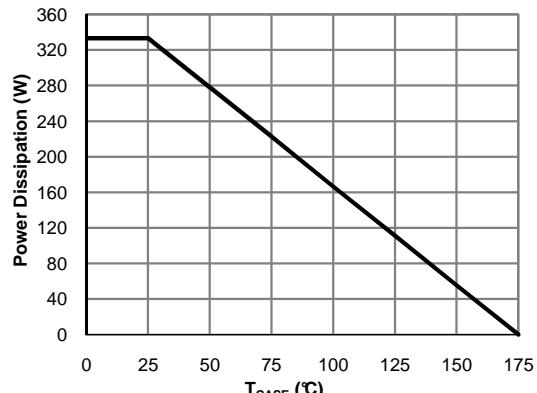


Figure 13: Power De-rating (Note F)

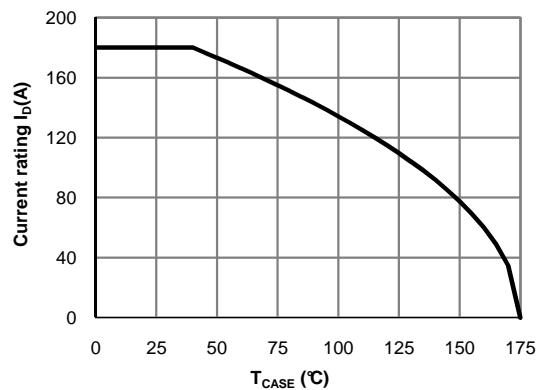


Figure 14: Current De-rating (Note F)

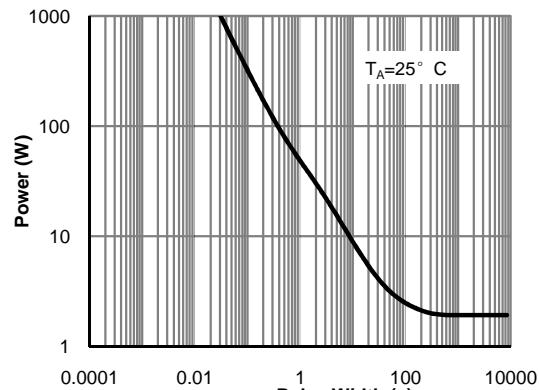


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H)

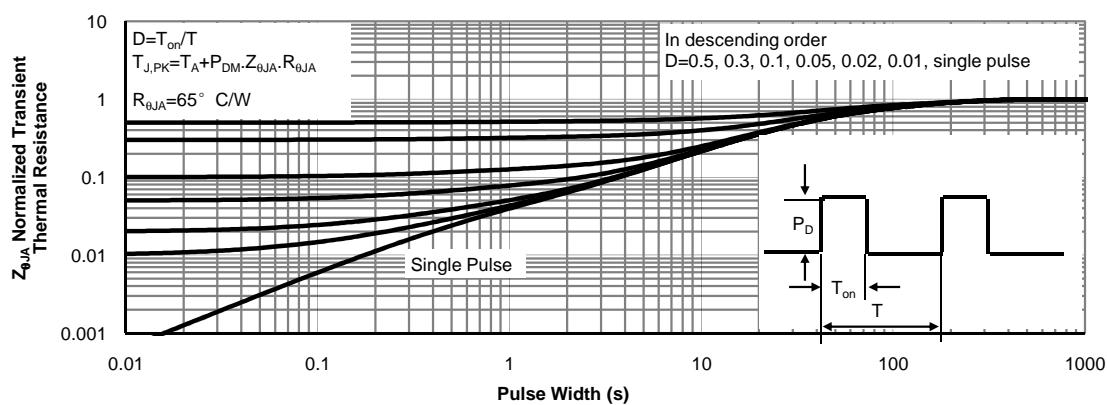


Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)

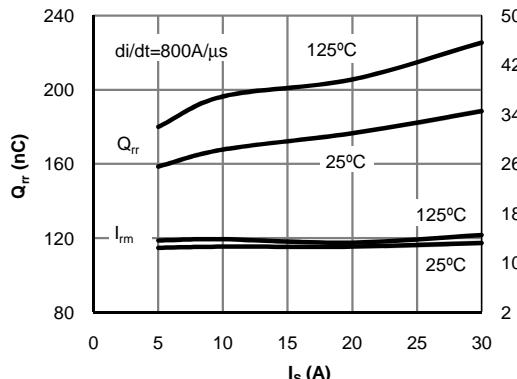
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 17: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current

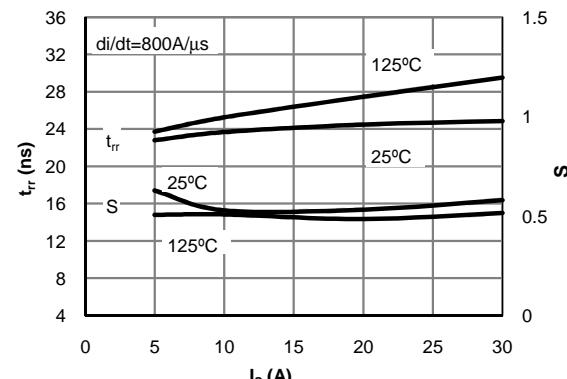


Figure 18: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current

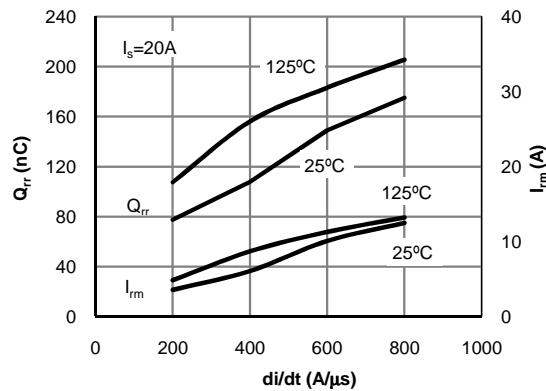


Figure 19: Diode Reverse Recovery Charge and Peak Current vs. di/dt

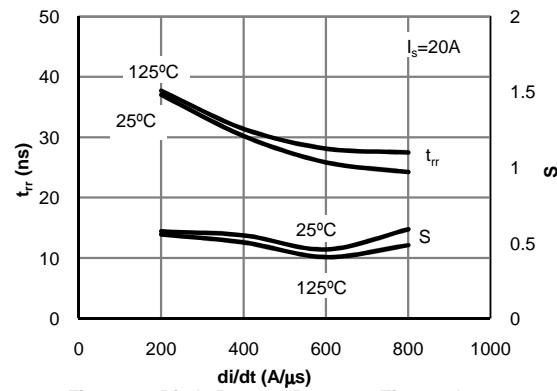
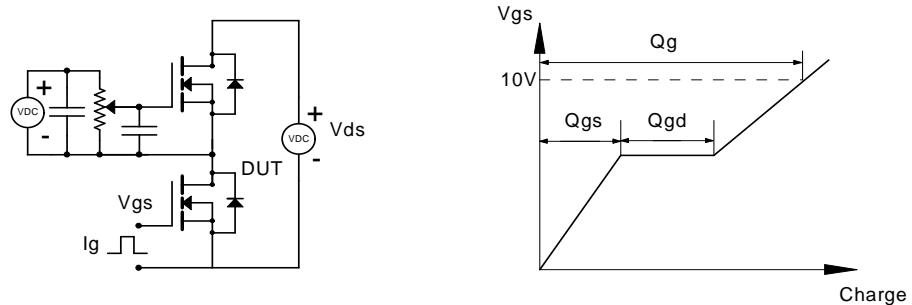
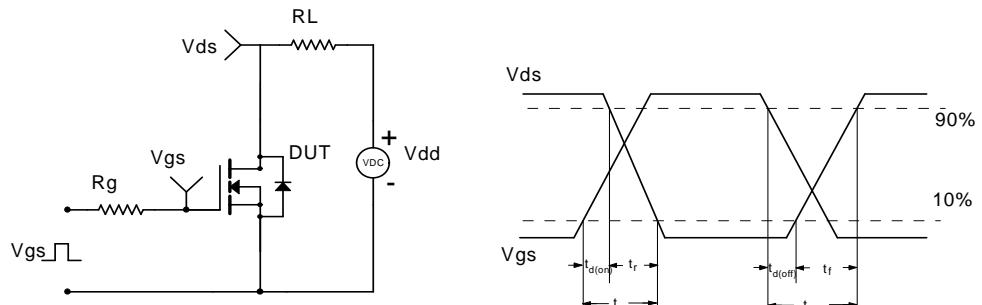
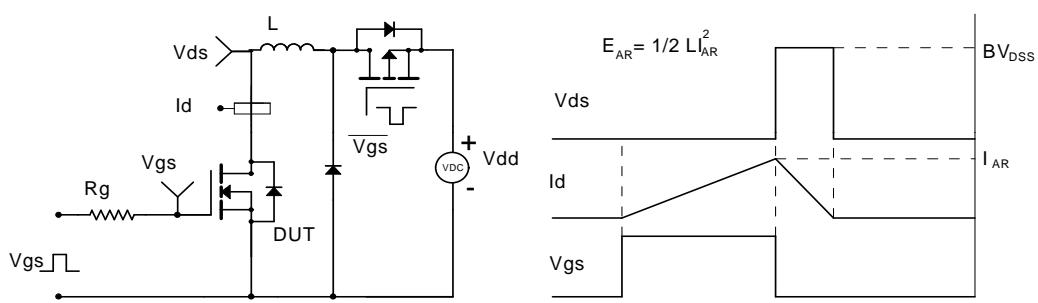
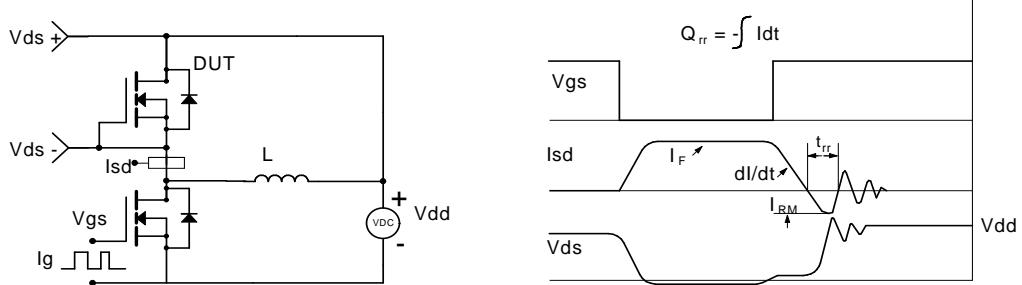


Figure 20: Diode Reverse Recovery Time and Softness Factor vs. di/dt


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